U.S. DEPARTMENT OF COMMERCE C 06-0	)6 - 2000 Patent and Tradema
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To the Honorable Commissioner of Patents and	ints or copy thereof.
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(Allewitz)	
Shinichi Kuroda	Name Came Comparison
Aditional name(s) of conveying party(ies) attached? U Yes 🛛 No	Name: <u>Sony Corporation</u> Internal Address:
3. Nature of Conveyance:	Street Address: 7-35 Kitashinagawa 6-chome
Assignment [] Merger	Shinagawa-ku, Tokyo, Japan
	City State ZIP
Security Agreement Change of Name	
L_ Other Execution Date: <u>April 17, 2000</u>	- Additional name(s) & address(es) attached? Yes X No
4. Application number(s) or patent number(s)	
If this document is being filed together with a new application, the executi	tion date of the application is:
A. Patent Application No.(s)	B. Patent No.(s)
1)9/ <b>49</b> 5.644	
Additional numbers at	
<ol> <li>Name and address of party to whom correspondence concerning document should be mailed:</li> </ol>	6. Total number of applications and patents involved:
Name: Jay H. Maioli	
Internal Address <u>Cooper &amp; Dunham LLP</u>	7 Total fee (37 CFR 3.41):\$ 40.00
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PATENT REEL: 010823 FRAME: 0690

## ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in <u>DIVERSITY</u> <u>RECEIVING APPARATUS</u> which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at6-7-35 Kitashinagawa, Shinagawa-Ku, Tokyo, Japan (hereinafter reference as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be graited therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole  $\odot$ r joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I herely authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And T further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereof;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents. for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereof

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

> PATENT REEL: 010823 FRAME: 0691

This assignment executed on the dates indicated below.

Shinichi Kuroda

Name of first or sole inventor

Execution date of U.S. Patent Application

Saitama, Japan

Residence of first or sole inventor

Signature of first or sole inventor

Apr 17 200

Date of this assignment